

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 6,875,634 B2
APPLICATION NO. : 10/804732
DATED : April 5, 2005
INVENTOR(S) : Shim et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 2

line 50, delete "FIGS. 6b through 6c" and insert therefor --FIGS. 6b and 6c--
line 62, delete "beat spreader" and insert therefor --heat spreader--

Column 6

line 5, delete "chemically a non-conductive material" and insert therefor
--chemically treating the first surface of heat spreader 14 with a non-conductive material--

Column 8

claim 1, line 44, delete "semicoductor" and insert therefor --semiconductor--
claim 1, line 48, delete "conductor" and insert therefor --semiconductor--

Column 9

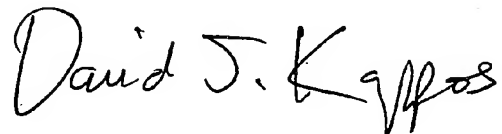
claim 2, lines 18-21,
delete "said anchor posts comprising deposits of thermally and electrically
conductive material, said thermally and electrically conductive material
having been cured after deposition thereof."
and insert therefor --said anchor posts being created during said die attach
process.--
claim 8, line 47, delete "mateial." and insert therefor --material.--

Column 10

claim 11, line 13, delete "material said" and insert therefor --material, said--

Signed and Sealed this

Twentieth Day of October, 2009

A handwritten signature in black ink, reading "David J. Kappos". The signature is written in a cursive, flowing style with a large initial 'D' and a stylized 'K'.

David J. Kappos
Director of the United States Patent and Trademark Office